

# **MOS Field Effect Power Transistors**

# 2SK2723

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for high current switching spplications.

#### FEATURES

- Low On-Resistance
  - RDS (on) 1 =  $40m\Omega$  Max. (VGS = 10 V, ID = 13 A) RDS (on) 2 =  $60m\Omega$  Max. (VGS = 4 V, ID = 13 A)
- Low Ciss Ciss = 830 pF Typ.
- Built-in G-S Protection Diode
- Isolated TO-220 Package



## MP-45F (ISOLATED TO-220)

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage Gate to Source Voltage Drain Current (DC) Drain Current (pulse)* Total Power Dissipation (T <sub>A</sub> = 25 °C)	VDSS VGSS ID (DC) ID (pulse) Ρτ	60 ±20 ±25 ±100 2.0	V V A A W	Gate Drain □ Drain □ □ Body □ Diode
Total Power Dissipation (T <sub>c</sub> = 25 °C) Channel Temperature Storage Temperature	P⊤ Tch Tstg	25 150 –55 to +150	W ℃ ℃	Gate Protection Diode Source
*PW $\leq$ 10 $\mu$ s, Duty Cycle $\leq$ 1%				

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this deveice acutally used, an additional protection circuit is externally required if voltage exceeding the rated voltage may be applied to this device.

The information in this document is subject to change without notice.

## ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source	RDS (on) 1	Vgs = 10 V, Id = 13 A		28	40	mΩ
On-state Resistance	RDS (on) 2	Vgs = 4 V, Id = 13 A		45	60	mΩ
Gate to Source Cutoff Voltage	VGS (off)	$V_{DS} = 10 V, I_{D} = 1 mA$	1.0	1.6	2.0	V
Forward Transfer Admittance	y fs	Vds = 10 V, Id = 13 A	8.0	18		S
Drain Leakage Current	IDSS	$V_{DS} = 60 V, V_{GS} = 0$			10	μA
Gate to Source Leakage Current	Igss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$			±10	μΑ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		830		pF
Output Capacitance	Coss	Vgs = 0		430		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		185		pF
Turn-On Delay Time	td (on)	ID = 13 A		21		ns
Rise Time	tr	VGS (on) = 10 V		185		ns
Turn-Off Delay Time	td (off)	Vdd = 30 V		100		ns
Fall Time	tr	R <sub>G</sub> = 10 Ω		110		ns
Total Gate Charge	QG	ID = 25 A		35		nC
Gate to Source Charge	QGS	V <sub>DD</sub> = 48 V		2.8		nC
Gate to Drain Charge	QGD	Vgs = 10 V		15		nC
Body Diode Forward Voltage	VF (S-D)	IF = 25 A, VGS = 0		1.0		V
Reverse Recovery Time	trr	IF = 25 A, VGS = 0		60		ns
Reverse Recovery Charge	Qr r	di/dt = 100 A/µs		125		nC

#### Test Circuit 1 Switching Time



#### Test Circuit 2 Gate Charge





VDS - Drain to Source Voltage - V

FORWARD TRANSFER CHARACTERISTICS









|y<sub>fs</sub> | - Forward Transfer Admittance

 $R_{DS(on)}$  - Drain to Source On-State Resistance - m $\Omega$ 

1

ID - Drain Current - A



100

DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

Pulsed

30

V<sub>DS</sub> = 10 V I<sub>D</sub> = 1 mA

150

Tch - Channel Temperature - °C



IF - Dionde Current - A



SWITCHING CHARACTERISTICS 1 000 ns ltr. td(on), tr, td(off), tr - Switching Time -100 td(off) td(on) 10 VDD =30V Vgs =10V  $R_{G} = 10\Omega$ 1 0.1 10 100 1 ID - Drain Current - A



#### REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	C10535E
Semiconductor device package manual.	C10943X
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	X10679E
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

[MEMO]

NEC

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Anti-radioactive design is not implemented in this product.